

• General Description

The AGM038N10A combines advanced trench MOSFET technology with a low resistance package to provide extremely low $R_{DS(ON)}$.

This device is ideal for load switch and battery protection applications.

Features

- Advance high cell density Trench technology
- Low R_{DS(ON)} to minimize conductive loss
- Low Gate Charge for fast switching
- Low Thermal resistance
- 100% Avalanche tested
- 100% DVDS tested

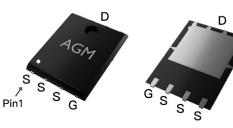
Application

- MB/VGA Vcore
- SMPS 2nd Synchronous Rectifier
- POL application
- BLDC Motor driver

Product Summary

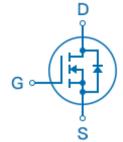
| BVDSS | RDSON | ID |
|-------|-------|------|
| 100V | 3.8mΩ | 120A |

PDFN5*6 Pin Configuration



Top View





Package Marking and Ordering Information

| Device Marking | Device | Device Package | Reel Size | Tape width | Quantity |
|----------------|------------|----------------|-----------|------------|----------|
| AGM038N10A | AGM038N10A | PDFN5*6 | 330mm | 12mm | 3000 |

Table 1. Absolute Maximum Ratings (TA=25℃)

| Symbol | Parameter | Value | Unit |
|-------------|---|-------|------------|
| VDS | Drain-Source Voltage (VGS=0V) | 100 | V |
| VGS | Gate-Source Voltage (VDS=0V) | ±20 | V |
| ID | Drain Current-Continuous(Tc=25℃) (Note 1) | 120 | А |
| _ | Drain Current-Continuous(T⊂=100°C) | 80 | А |
| IDM (pluse) | Drain Current-Pulsed (Note 2) | 480 | А |
| PD | Maximum Power Dissipation(Tc=25℃) | 147 | w |
| | Maximum Power Dissipation(Tc=100℃) | 58 | W |
| EAS | Avalanche energy (Note 3) | 529 | mJ |
| TJ,TSTG | TG Operating Junction and Storage Temperature Range | | $^{\circ}$ |

Table 2. Thermal Characteristic

| Symbol | Parameter | Тур | Max | Unit |
|--------|---|-----|------|------|
| RθJA | Thermal Resistance Junction-ambient (Steady State) ¹ | | 20 | °C/W |
| RøJC | Thermal Resistance Junction-Case ¹ | | 0.85 | °C/W |



Table 3. Electrical Characteristics (TJ=25°C unless otherwise noted)

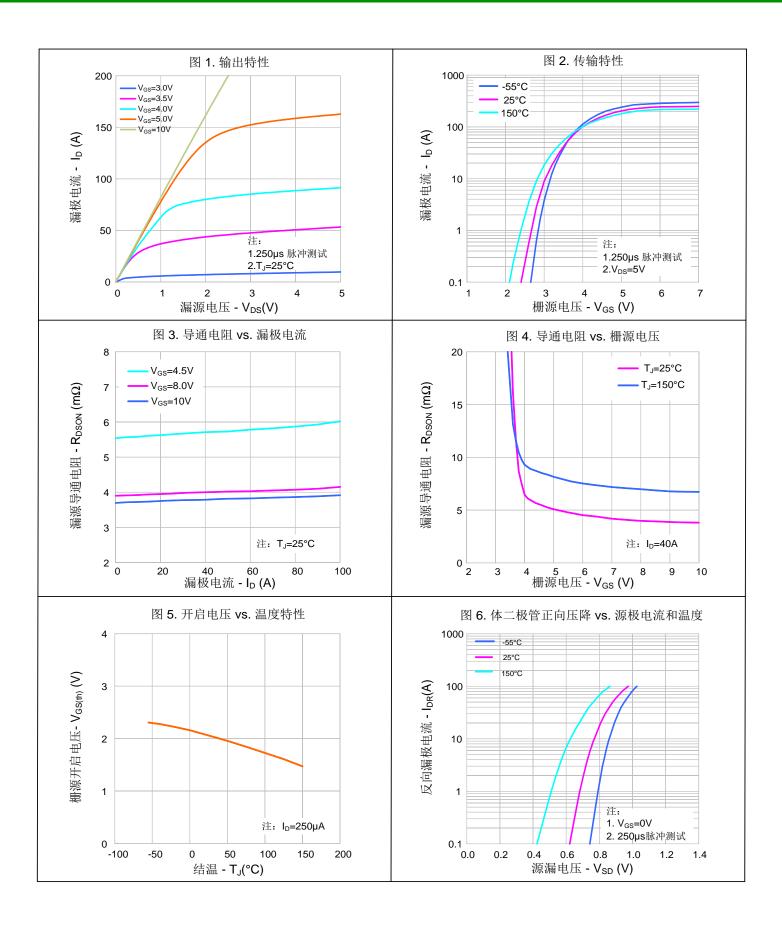
| Symbol | Electrical Characteristics (TJ=25°C unli Parameter | Conditions | Min | Тур | Max | Unit |
|------------|---|-----------------------------|-----|------|------|------|
| On/Off Sta | tes | | | | | |
| BVDSS | Drain-Source Breakdown Voltage | VGS=0V ID=250µA | 100 | | | V |
| IDSS | Zero Gate Voltage Drain Current | VDS=100V,VGS=0V | | | 1 | μΑ |
| IGSS | Gate-Body Leakage Current | VGS=±20V,VDS=0V | | | ±100 | nA |
| VGS(th) | Gate Threshold Voltage | VDS=VGS,ID=250μA | 1.2 | 1.8 | 2.2 | V |
| gFS | Forward Transconductance | VDS=5V,ID=20A | | 52 | | S |
| RDS(on) | Drain-Source On-State Resistance | VGS=10V, ID=30A | | 3.8 | 5.0 | mΩ |
| 1.20(0) | | VGS=4.5V, ID=20A | | 5.7 | 7.5 | mΩ |
| Dynamic C | Characteristics | | | | | |
| Ciss | Input Capacitance | VDS=50V,VGS=0V, | | 4739 | | pF |
| Coss | Output Capacitance | F=1MHZ | | 622 | | pF |
| Crss | Reverse Transfer Capacitance | | | 16 | | pF |
| Rg | Gate resistance | VGS=0V, VDS=0V,f=1.0MHz | | 3.3 | | Ω |
| Switching | Times | | | | | |
| td(on) | Turn-on Delay Time | | | 21 | | nS |
| tr | Turn-on Rise Time | VGS=10V,VDS=50V, | | 80 | | nS |
| td(off) | Turn-Off Delay Time | ID=30A,RGEN=3Ω | | 69 | | nS |
| tf | Turn-Off Fall Time | | | 30 | | nS |
| Qg | Total Gate Charge | | | 67 | | nC |
| Qgs | Gate-Source Charge | VGS=10V, VDS=50V, ID=30A | | 24 | | nC |
| Qgd | Gate-Drain Charge | ID-30A | | 11 | | nC |
| Source-Dr | ain Diode Characteristics | | • | • | | |
| ISD | Source-Drain Current(Body Diode) | | | | 120 | Α |
| VSD | Forward on Voltage | VGS=0V,IS=30A | | | 1.2 | V |
| trr | Reverse Recovery Time | IF=30A , dI/dt=100A/μs , | | 60 | | ns |
| Qrr | Reverse Recovery Charge | TJ=25℃ | | 89 | | nc |

Notes 1. The maximum current rating is package limited.

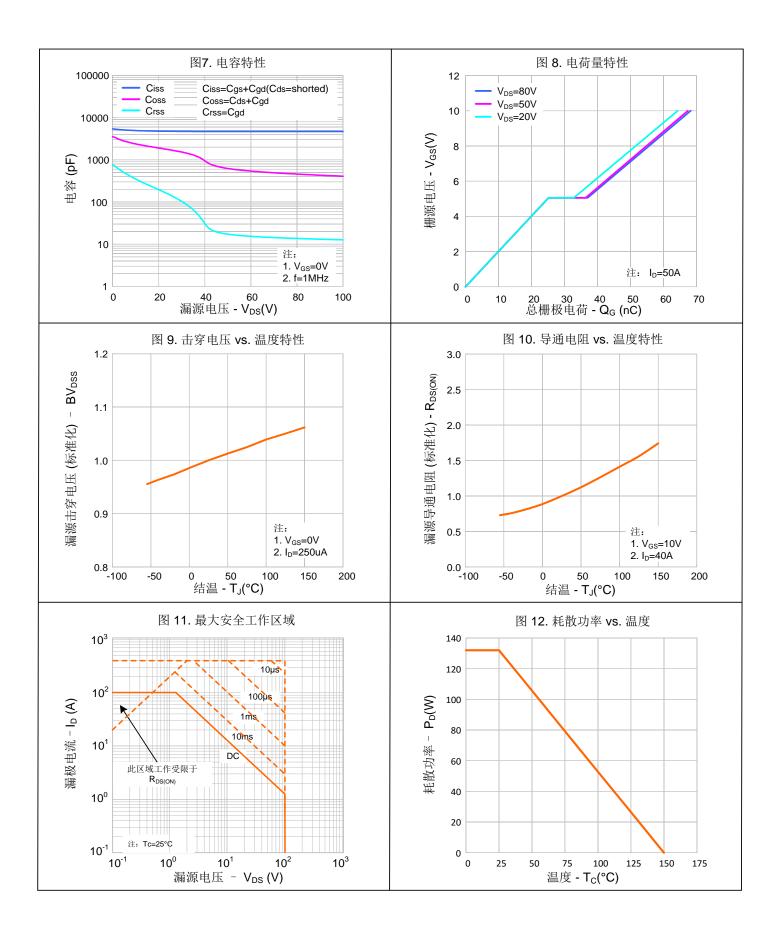
Notes 2.Repetitive Rating: Pulse width limited by maximum junction temperature

Notes 3.EAS condition: TJ=25 $^{\circ}\text{C},\text{VDD}=50\text{V},\text{Vgs}=10\text{V},\text{ID}=46\text{A},\text{L}=0.5\text{mH},\text{RG}=25\text{ohm}$



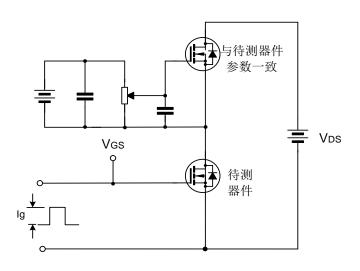


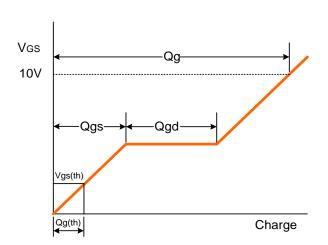




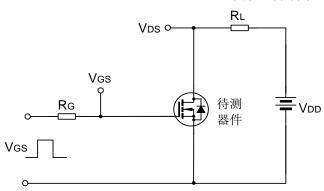


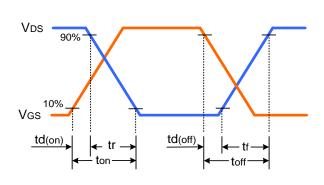
栅极电荷量测试电路及波形图



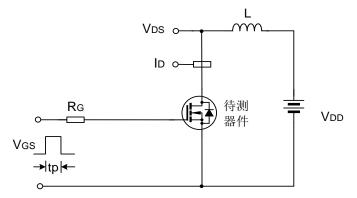


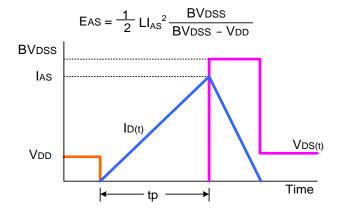
开关时间测试电路及波形图





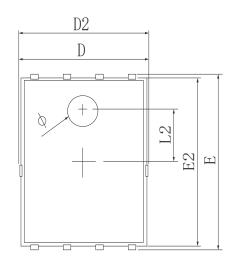
EAS测试电路及波形图

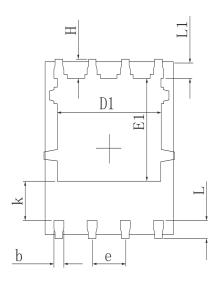


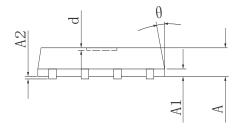




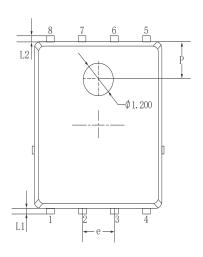
•Dimensions (PDFN5*6)

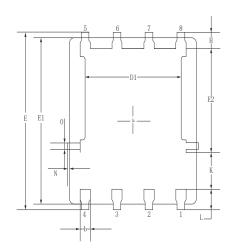


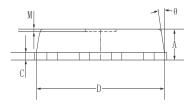




| | MILLIMETER | | | |
|--------|------------|------------|--------|--|
| SYMBOL | MIN | Тур. | MAX | |
| A | 0.900 | 1.000 | 1.100 | |
| A1 | | 0.254 REF. | | |
| A2 | | 0~0.05 | | |
| D | 4. 824 | 4.900 | 4.976 | |
| D1 | 3. 910 | 4.010 | 4.110 | |
| D2 | 4. 924 | 5.000 | 5. 076 | |
| Е | 5. 924 | 6.000 | 6.076 | |
| E1 | 3. 375 | 3. 475 | 3. 575 | |
| E2 | 5. 674 | 5. 750 | 5. 826 | |
| b | 0.350 | 0.400 | 0.450 | |
| е | | 1.270 TYP. | | |
| L | 0.534 | 0.610 | 0.686 | |
| L1 | 0.424 | 0.500 | 0.576 | |
| L2 | 1.800 REF. | | | |
| k | 1. 190 | 1. 290 | 1.390 | |
| Н | 0. 549 | 0.625 | 0.701 | |
| θ | 8° | 10° | 12° | |
| Ф | 1.100 | 1.200 | 1.300 | |
| d | | | 0.100 | |





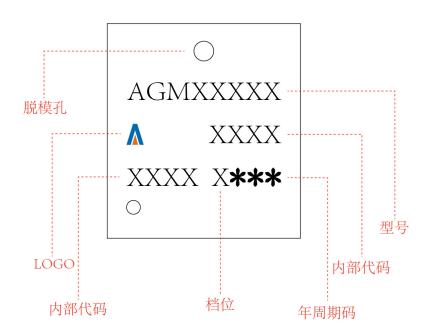


| 0 1 1 | Millimeters | | | |
|--------|-------------|-------|-------|--|
| Symbol | MIN. | NOM. | MAX. | |
| A | 0.90 | 1.05 | 1. 20 | |
| В | 0.35 | 0.40 | 0.50 | |
| С | 0.20 | 0. 25 | 0.35 | |
| D | 4.90 | 5. 05 | 5. 20 | |
| D1 | 3. 72 | 3. 82 | 3. 92 | |
| Е | 6.00 | 6. 15 | 6.30 | |
| E1 | 5. 60 | 5. 75 | 5. 90 | |
| E2 | 3. 47 | 3. 57 | 3. 67 | |
| е | 1.27 BSC. | | | |
| Н | 0.48 | 0. 58 | 0.68 | |
| K | 1. 17 | 1. 27 | 1. 37 | |
| L | 0.64 | 0.74 | 0.84 | |
| L1/L2 | 0.20 REF. | | | |
| θ | 8° | 10° | 12° | |
| M | 0.08 REF. | | | |
| N | 0 | - | 0.15 | |
| 0 | 0.25 REF. | | | |
| P | 1.28 REF. | | | |

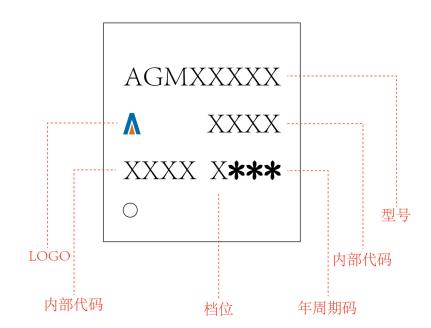


PDFN5*6 Marking Instructions:

Model1:



Model2:





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